

0.65X0.35mm SMD CHIP LED LAMP (0.2mm Height)

Part Number: APG0603SEC-E-TT Hyper-Red

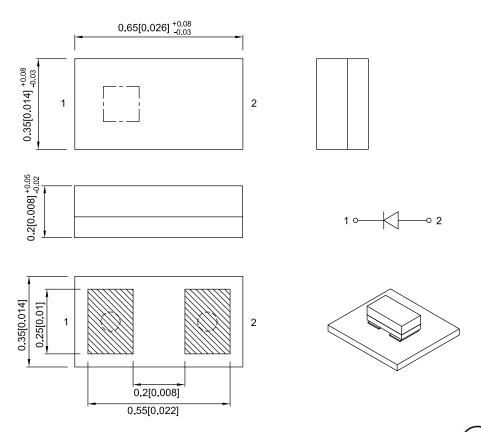
Features

- 0.65mmX0.35mm SMD LED,0.2mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Package:4000pcs/reel.
- Moisture sensitivity level : level 2.
- RoHS compliant.

Description

The Hyper-Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	. Emitting Color (Material) Lens Type		Iv (mcd) [2] @ 10mA		Viewing Angle [1]
		Min.	Тур.	201/2	
APG0603SEC-E-TT	Hyper-Red(AlGalnP)	Water Clear	45	120	- 140°
			*15	*40	

- $1. \theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper-Red	632		nm	IF=10mA
λD [1]	Dominant Wavelength	Hyper-Red	624		nm	IF=10mA
Δλ1/2	Spectral Line Half-width	Hyper-Red	20		nm	I==10mA
VF [2]	Forward Voltage	Hyper-Red	1.93	2.4	V	I==10mA
lR	Reverse Current	Hyper-Red		10	uA	V _R =5V

Notes:

- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

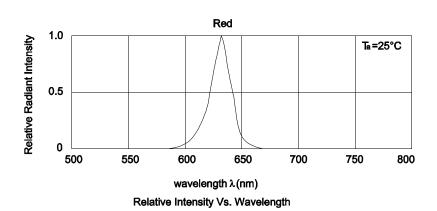
Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units	
Power dissipation	tion 48		
DC Forward Current	20	mA	
Peak Forward Current [1]	100	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

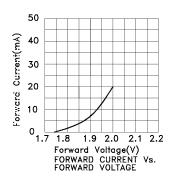
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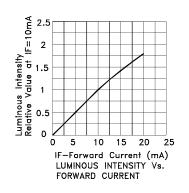
Kingbright

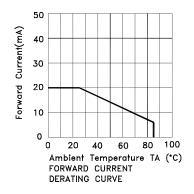


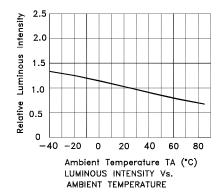
Hyper-Red

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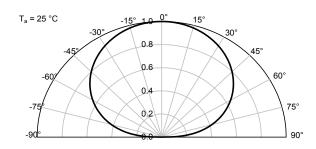








Spatial Distribution



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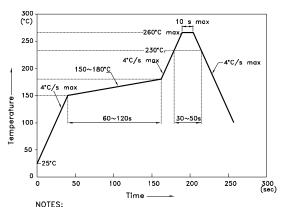
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



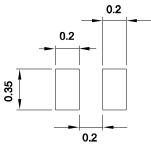
10.1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

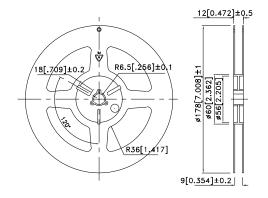
Recommended Soldering Pattern

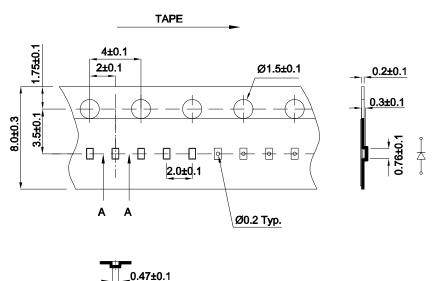
(Units: mm; Tolerance: ± 0.1)

Reel Dimension









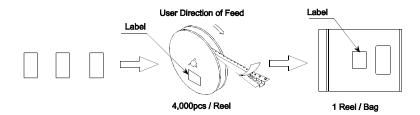
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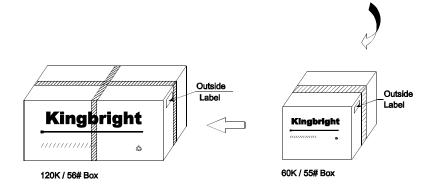
A-A SECTION



PACKING & LABEL SPECIFICATIONS

APG0603SEC-E-TT







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